

## **Excellent Integrated System Limited**

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Rohm Semiconductor RDX120N50FU6

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**Distributor of Rohm Semiconductor: Excellent Integrated System Limited** Datasheet of RDX120N50FU6 - MOSFET N-CH 500V 12A TO-220FM Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

## Transistors

## RDX120N50

# 10V Drive Nch MOS FET RDX120N50

#### Structure

Silicon N-channel MOS FET

#### Features

1) Low on-resistance.

- 2) Low input capacitance.
- 3) Excellent resistance to damage from static electricity.

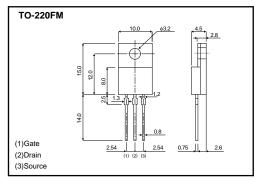
#### Applications

Switching

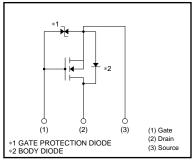
#### Packaging specifications

	Package	Bulk		
Туре	Code	-		
	Basic ordering unit (pieces)	500		
RDX120N50		0		

#### •External dimensions (Unit : mm)



#### Inner circuit



#### •Absolute maximum ratings (Ta=25°C)

		-			
Parameter		Symbol		Limits	Unit
Drain-source voltage		V <sub>DSS</sub>		500	V
Gate-source voltage		Vgss		±30	V
Droin eurrent	Continuous	ID	*1	±12	A
Drain current	Pulsed	I <sub>DP</sub>	*2	±48	A
Source current (Body diode)	Continuous	ls		12	A
	Pulsed	Isp	*2	48	A
Avalanche current		las	*3	12	A
Avalanche energy		Eas	*4	260	mJ
Total power dissipation (Tc=25°C)		PD		45	W
Channel temperature		Tch		150	°C
Range of storage temperature		Tstg		-55 to +150	°C
*1 Limited only by maximum temperatur	e allowed *2	Pw <10us ∣	Duty c	vcle<1%	

\*1 Limited only by maximum temperature allowed \*2 Pw  $\leq$ 10µs, Duty cycle  $\leq$ 1% \*3 L = 3.1mH Vpp=90V Rg=25\Omega startingTch=25°C

#### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to case	Rth(ch-c)	2.78	°C/W



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## Transistors

#### •Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μΑ	$V_{GS}=\pm 25V, V_{DS}=0V$
Drain-source breakdown voltage	V(BR) DSS	500	-	_	V	I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	-	25	μΑ	V <sub>DS</sub> = 500V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	2.0	-	4.0	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	_	0.38	0.5	Ω	I <sub>D</sub> = 6A, V <sub>GS</sub> = 10V
Forward transfer admittance	Y <sub>fs</sub> *	5.0	8.0	-	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6A
Input capacitance	Ciss	-	1600	-	pF	V <sub>DS</sub> = 25V
Output capacitance	Coss	-	200	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	-	35	-	pF	f=1MHz
Turn-on delay time	${ m t}$ d (on) $^{*}$	-	25	-	ns	Vdd≒ 150V
Rise time	tr *	-	17	-	ns	ID= 6A Vgs= 10V
Turn-off delay time	td (off) $*$	_	80	_	ns	$R_{L}=25\Omega$
Fall time	tr *	_	44	-	ns	Rg=10Ω
Total gate charge	Qg *	-	45	-	nC	V <sub>DD</sub> ≒250V
Gate-source charge	Qgs *	-	8	-	nC	V <sub>GS</sub> = 10V
Gate-drain charge	Q <sub>gd</sub> *	-	15	-	nC	I <sub>D</sub> = 12A

\*Pulsed

#### •Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsd *	-	-	1.5	V	Is= 12A, V <sub>GS</sub> =0V
Reverse recovery time	trr	-	550	-	ns	I <sub>DR</sub> = 12A, V <sub>GS</sub> =0V
Reverse recovery charge	Qrr	-	4.7	-	μC	di/dt= 100Α / μs

\* Pulsed



## Appendix

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